The 21st Biennial Conference on Electromagnetic Field Computation

IEEE CEFC 2024

2 - 5 June 2024 | ICC, jeju, Korea

Sponsorship & Exhibition Prospectus





I. Greetings

Dear Colleagues,

Welcome to CEFC 2024, Jeju, Korea!

It is our great pleasure to welcome you to the 21st Biennial IEEE Conference on Electromagnetic Field Computation (IEEE CEFC 2024), which will be held in Jeju, Korea, June 2 – 5, 2024. This conference will be a full face—to—face one, and we hope, by then, Covid19 will be completely forgotten from our minds, and it will be an opportunity to be with our colleagues we haven't met for a long time. The conference will be cosponsored by IEEE Magnetics Society, Korean Institute of Electrical Engineers – Electric Machines and Energy Conversion System Society, and Chungbuk National University.

This IEEE conference focuses on the latest developments in modeling and simulation methodologies for the analysis of electromagnetic fields and wave interactions, with applications emphasis on computer-aided design of low and high frequency devices, components, and systems.

We strongly believe IEEE CEFC 2024 will be a great opportunity for participants to exchange the latest information, ideas, and experiences in computational electromagnetics and related fields. And your contributions of papers and presentations as well as participation will surely make the event even more fruitful. Also, our participants will have the chance to explore the beautiful Jeju Island while joining the social activities we have planned for you.

We would like to offer great opportunities for you to support this conference and showcase your professional services and innovative materials and equipment through sponsoring and exhibiting. We hope you would take advantage of this opportunity to promote your products and services to global attendees of antennas and propagation in IEEE CEFC 2024.

Thank you very much.

Sincerely,

Conference Chairs of CEFC 2024

Prof. Chang-Seop Koh (Chungbuk National University)

Prof. Sang-Yong Jung (Sungkyunkwan University)



II. Outline

Conference Title	The 21st Biennial IEEE Conference on Electromagnetic Field Computation		
Date	June 2 (Sun.) – 5 (Wed.), 2024		
Location	ICC, Jeju, Korea		
Туре	In-person Conference		
Attendees	450 Attendees (Expected)		
Programs	 Plenary Talks Oral & Poster Sessions Welcome Reception Coffee Breaks Banquet Closing & Awards 		
Organizer	IEEE Magnetics Society The Korean Institute of Electrical Engineers (KIEE)		
Homepage	http://cefc2024.com		
Language	English		

III. Important Date

Two-page Digest Submission	November 17, 2023
Notification of Acceptance	February 7, 2024
Early Registration	March 24, 2024
Full Paper Due for IEEE Transactions on Magnetics Review	June 14, 2024 (No Extension)



IV. Committee

International Steering Committee		
Sami Barmada (Chair)	Italy	
Christos S. Antonopoulos	Greece	
Abd A. Arkandan	USA	
Anouar Belahcen	Finland	
Ermanno Cardelli	Italy	
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Markus Clemens	Germany	
Alessandro Formisano	Italy	
Yasushi Kanai	Japan	
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David Lowther	Canada	
Osama Mohammed	USA	
Lionel Pichon	France	
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Shiyou Yang	China	

Conference Chairs	
Chang-Seop Koh	Chungbuk National University, Korea
Sang-Yong Jung	Sungkyunkwan University, Korea

Editorial Board Chairs		
Anouar Belahcen	Aalto University, Finland	
Gwan Soo Park	Pusan National University, Korea	



IV. Committee

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Hyun-Kyo Jung (Honorary)	Seoul National University		
Kyeong Choi (Honorary)	Kangwon National University		
Woo-Cheol Lee	Hankyong National University		
Chang Eob Kim	Hoseo University		
Finance			
Sun-Ki Hong (Chair)	Hoseo University		
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Myung-Seop Lim	Hanyang University		
Dong-Kuk Lim	University of Ulsan		
Han-Kyeol Yeo	The University of Suwon		
Jangho Seo	Kyungpook National University		
Sung-II Kim	Hoseo University		
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Jaewon Lim	Korea Institute of Machinery & Materials		
Ho-Chang Jung	Korea Automotive Technology Institute		
Jae Won Moon	Korea Testing Certification Institute		
Jae-Gil Lee	Korea Electrotechnology Research Institute		
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Seok-Won Jung	Sungkyunkwan University		
Jaehyuck Kim	Wonkwang University		
Jae-Woo Jung	Daegu University		
Jin-hwan Lee	Chonnam National University		
General Secretary			
Jang-Young Choi	Chungnam National University		



IV. Committee

Technical Program Committee		
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Kyeongdal Choi	Tech University of Korea, Korea	
Sun-Ki Hong	Hoseo University, Korea	
Seok-Won Jung	Sungkyunkwan University, Korea	
Sungtek Kahng	Incheon National University, Korea	
Yong-Jae Kim	Chosun University, Korea, Korea	
Dong-Kuk Lim	University of Ulsan, Korea	
Kazuhiro Muramatsu	Saga University, Japan	
Gwan Soo Park	Pusan National University, Korea	
Jong-Suk Ro	Chung-Ang University, Korea	
Jung-Moo Seo	Korea Electronics Technology Institute, Korea	
Han-Kyeol Yeo	The University of Suwon, Korea	
Yanli Zhang	Shenyang University of Technology, China	



V. Sponsorship Information

We cordially introduce special opportunities for your company.

Your sponsorship in this exciting event will provide excellent opportunities for your company to expose high quality products and services to the experts from all parts of the world.

X All sponsorship categories are filled on first-come, first-served basis.

| Application Procedure

- Please download the Sponsorship Application form, fill out and e-mail it to the CEFC 2024 Secretariat (cefc2024@cefc2024.com).
- All payments should be transferred to the bank account within 2 weeks of submitting the application.
- Please send the receipt to the secretariat for confirmation of full payment.

| Application Deadline

May 1 (Wed.), 2024

| Sponsorship Levels & Benefits

Category		Sponsorship Level & Amount				
	Category		Diamond	Gold	Silver	Bronze
	Benefits	KRW 10,000,000	KRW 7,000,000	KRW 5,000,000	KRW 3,000,000	KRW 2,000,000
Advertiseme	nt on the Program Book	2 Pages	1 Page	1 Page	1/2 Page	1/2 Page
	Program Book	0	0	0	0	0
	Webmail Newsletters	0	0	0	0	0
Logo Printing	Banner at the Venue	0	0	0	0	0
	Strap of the Name Badge	0	-	_	_	-
Web Banner	Website Main Page	0	0	0	0	0
(Logo + Link)	Website Sponsor Page	0	0	0	0	0
Video Advertisement during Break		0	0	0	_	_
Free Registration		5 Persons	3 Persons	2 Persons	1 Person	_
Exhibition Booth(s)		3	2	1	_	-

^{*}Aside from the defined packs, we also welcome supports from interested companies and organizations with a minimum sponsorship at KRW 1,000,000.



Sponsorship Application Form

Please fill out the below application form, and send it back to the secretariat.

CEFC 2024 Secretariat

E-mail:cefc2024@cefc2024.com / Tel: +82-42-472-7460 / Fax: +82-42-472-7459

| Company Information

Company Name		
President Name		
Website		
Address		
City / Country	Postal Code	
Telephone	Mobile	
E-mail	Fax	
Contact Person Name		
Job Title	Department	

| Sponsorship

Level	KRW	Apply (Check "O")
Platinum	KRW 10,000,000	
Diamond	KRW 7,000,000	
Gold	KRW 5,000,000	
Silver	KRW 3,000,000	
Bronze	KRW 2,000,000	
Supporter	KRW 1,000,000	

Account Information

Bank Name	HANA Bank
Branch Name	Gangnam Branch
Account Holder	The Korean Institute of Electrical Engineers (KIEE)
Account Number	591-910063-75304
Swift BIC	KOEXKRSE
Bank Address	126 ,Teheran-ro ,Gangnam-gu,Seoul(823-21 Yeoksam-dong)

Name of Applicant:	Date:	
	Signature:	



VI. Exhibition Information

Our Organizing Committee of CEFC 2024 welcomes exhibitors from interested companies and institutions. Whether you are seeking to enhance brand recognition, reinforce your reputation as an industry leader, or establish a new business, CEFC 2024 support will enable you to achieve your goals at this highly attended conference.

* The Exhibition booths are on first-come, first-served basis.

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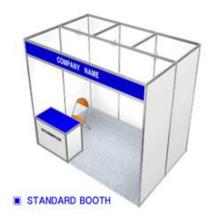
| Exhibition Opportunity

Category	Fee	
Exhibition Booth	KRW 3,000,000 (1EA)	

Benefits for Exhibitors (Per One Booth)

- 1 Free Registration
- · Logo and Web Link on the Website
- Logo on the Program Book

| Booth Information



Shell Scheme Package (Per One Booth)

- Size: 3m(W) *2m(L) *2.5m(H)
- 1 information desk / 2 chairs
- · Lighting and 1KW of power



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| Company Information

Company Name		
President Name		
Website		
Address		
City / Country	Postal Code	
Telephone	Mobile	
E-mail	Fax	
Contact Person Name		
Job Title	Department	

| Exhibition

Category	Quantity	Total Amount
Standard (1 EA = KRW 3,000,000)	booth(s)	KRW

| Account Information

Bank Name	HANA Bank
Branch Name	Gangnam Branch
Account Holder	The Korean Institute of Electrical Engineers (KIEE)
Account Number	591-910063-75304
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Name of Applicant:		Date:	

Signature: